

Si-W ECAL activities

Daniel Jeans for the

CALICE-ASIA SiW ECAL groups
@ Kyushu, Tokyo

Tokusui annual meeting, KEK, December 2013



Silicon-W ECAL : CALICE / ILD

Active groups:

France

LLR, LAL, LPSC, LPC, LPNHE

Japan

Kyushu, Tokyo

Korea

SKKU

Physics prototype (data-taking 2006 – 2011)

Proof of principle

up to ~10k readout channels

many beam tests with muons, e+-, hadrons

Technological prototype (2010-)

Ready to integrate into detector

Embedded electronics

Power pulsing

Industrialisable technologies and construction

ILD studies

Sensor development & mass testing

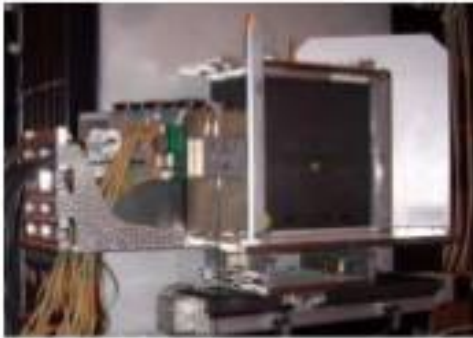
Optimisation: performance, cost

Reconstruction, analysis

Physics Prototype

Proof of principle

2003 - 2011



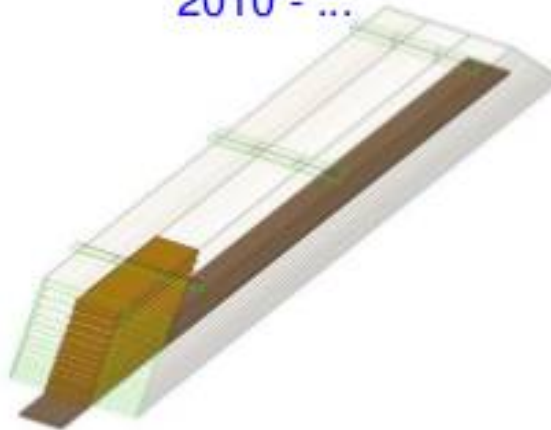
Number of channels : 9720

Weight : ~ 200 Kg

Technological Prototype

Engineering challenges

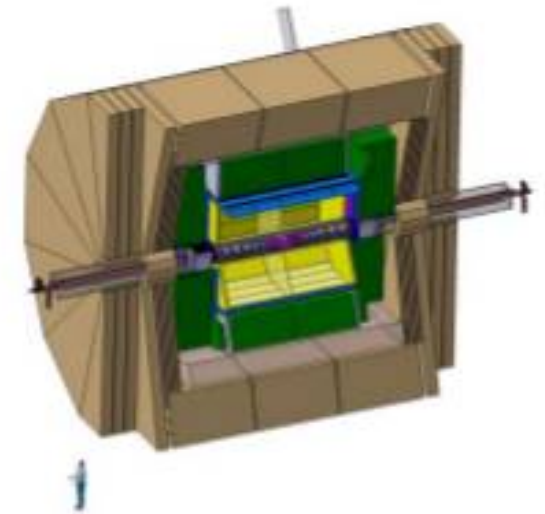
2010 - ...



Number of channels : 45360

Weight : ~ 700 Kg

LC detector



ECAL :

Channels : ~100 10⁶

Total Weight : ~130 t

Physics prototype data analysis

Miyazaki

EM response using data collected at FNAL in 2008

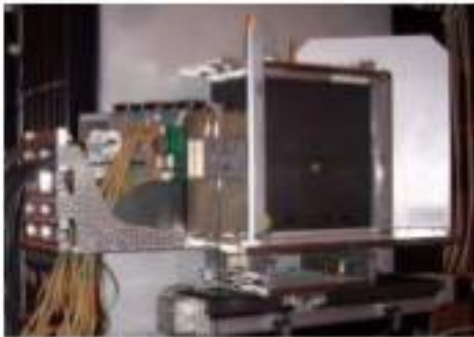
Chen

2-particle separation using over-layed events & Pandora PFA

Physics Prototype

Proof of principle

2003 - 2011



Number of channels : 9720

Weight : ~ 200 Kg

Measure ECAL response using events collected at Fermilab test beam in 2008 using positron beams in energy range 4-20 GeV

Compare to results of 2006 test beam at CERN.

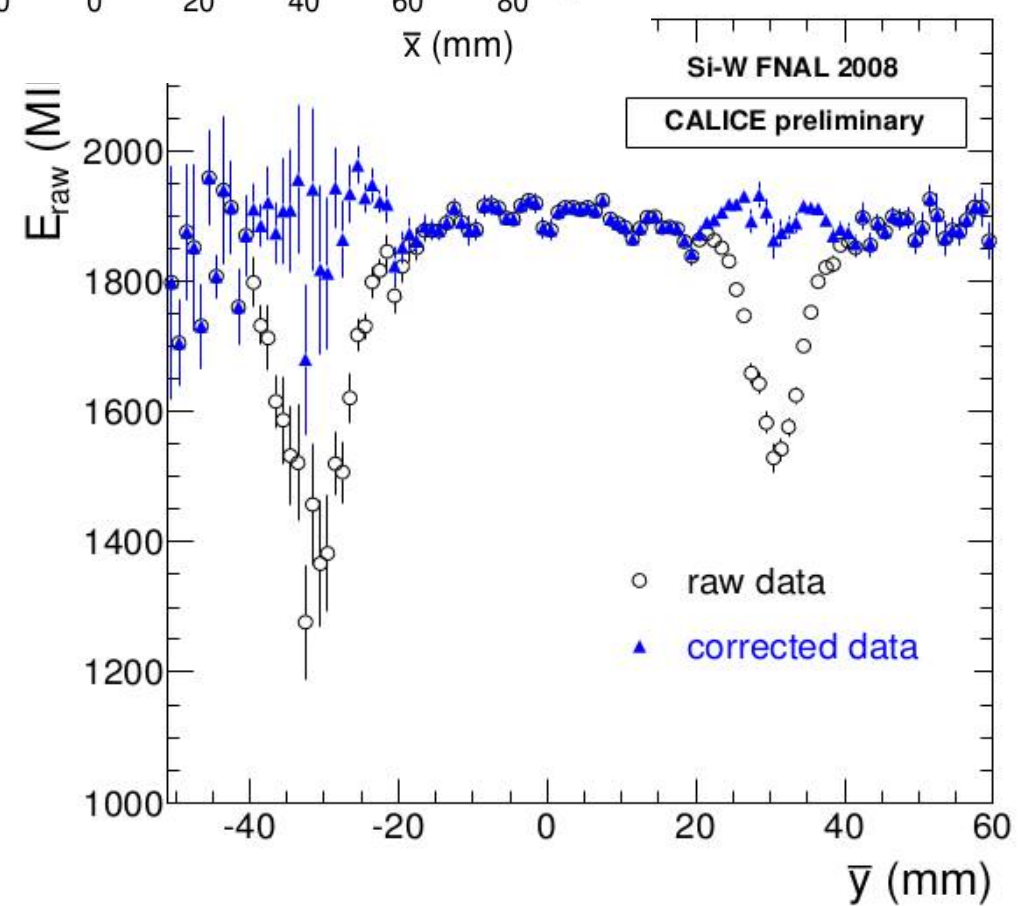
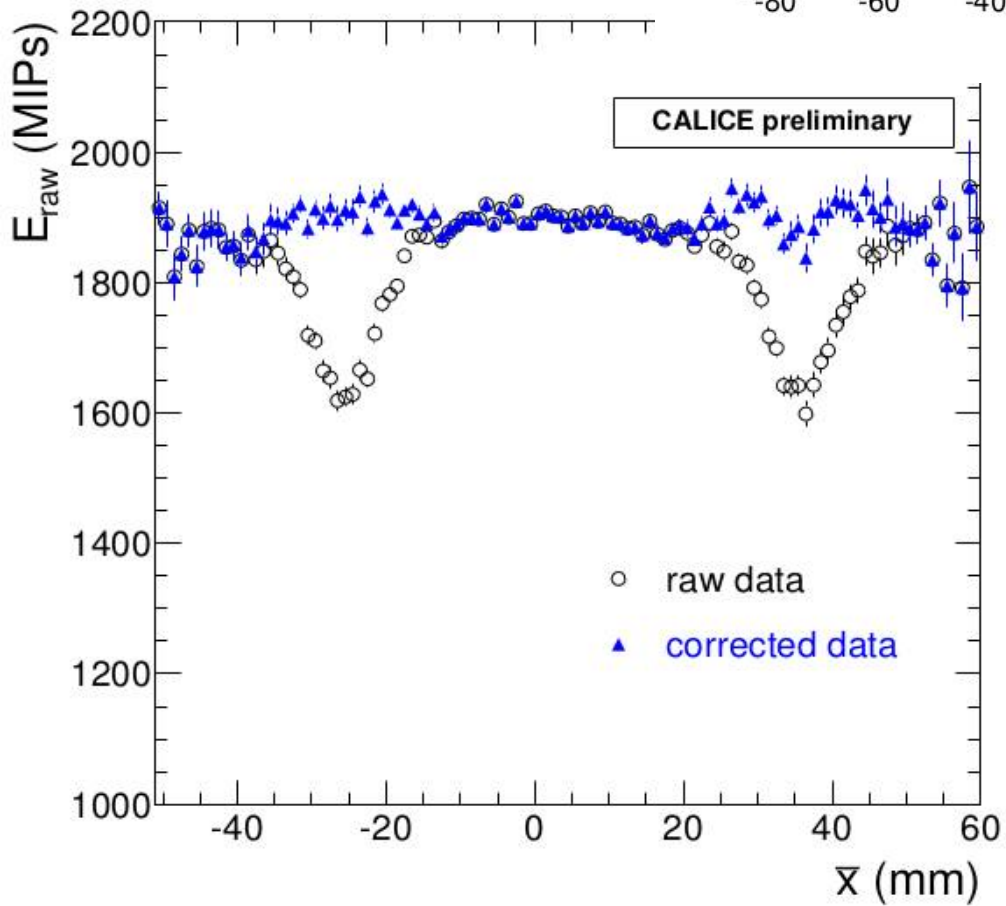
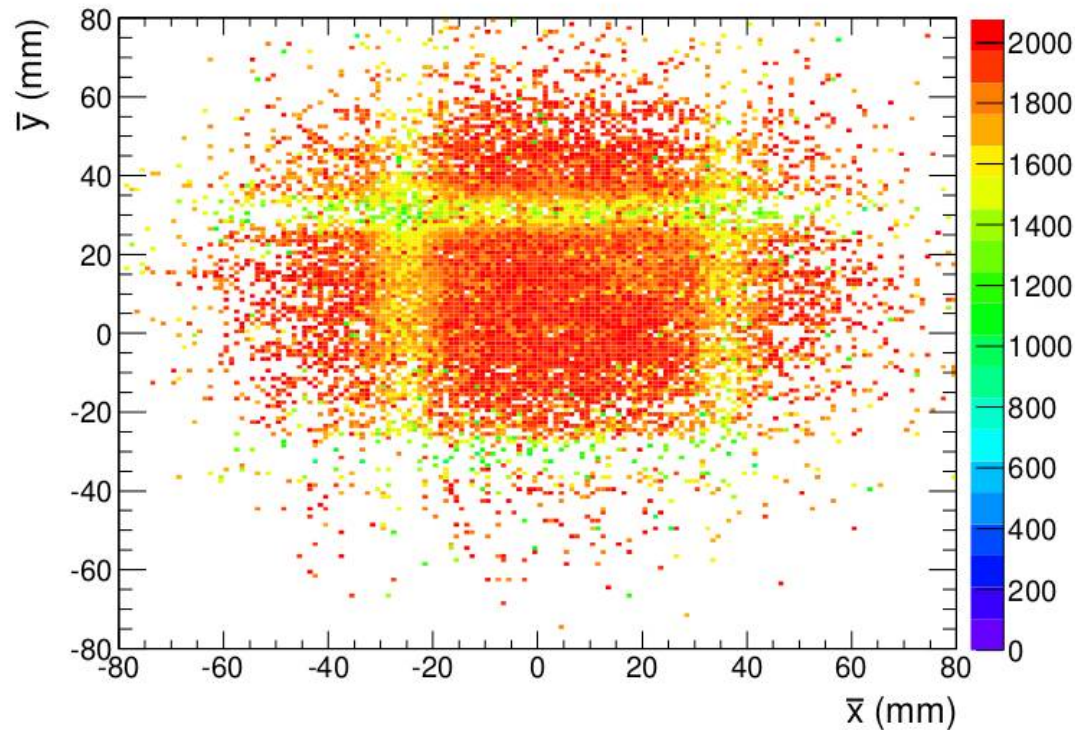
Demonstrate stable long-term behaviour

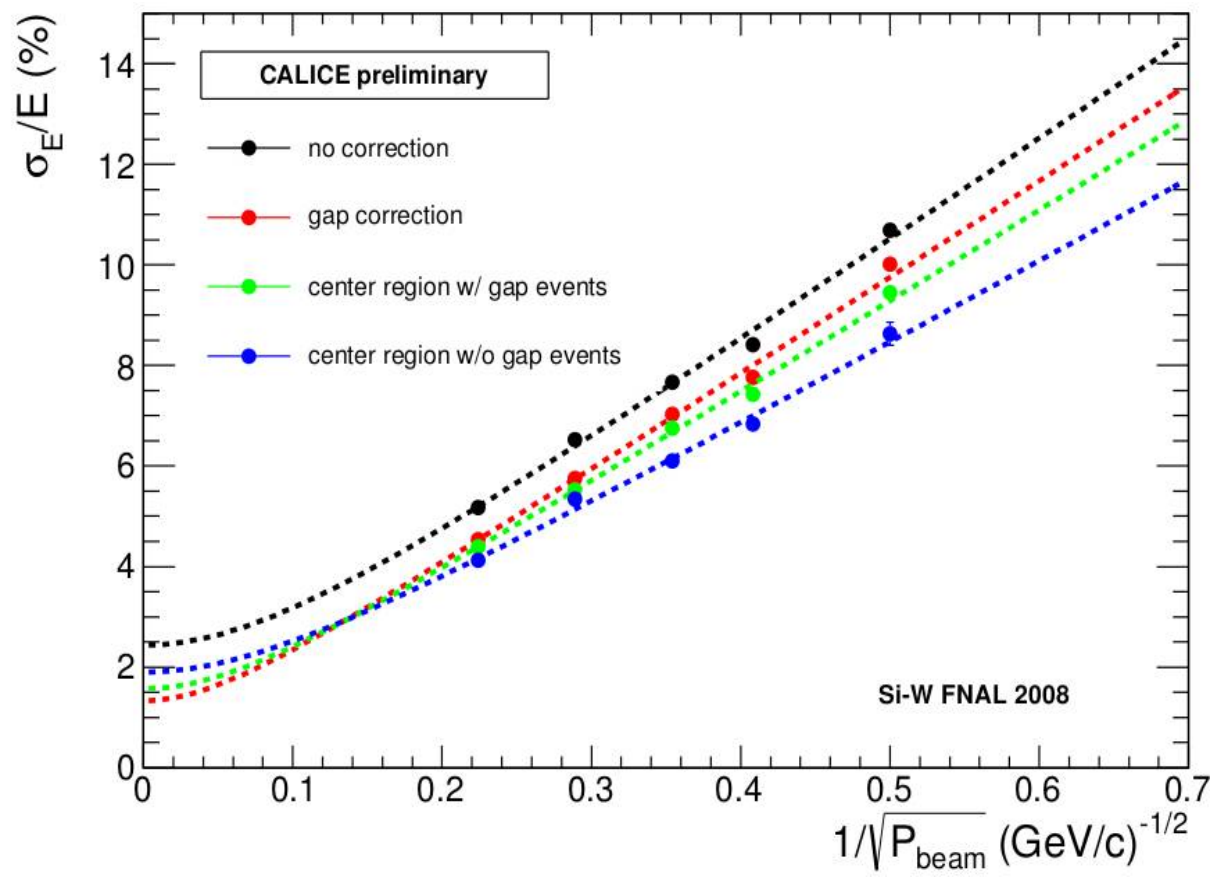
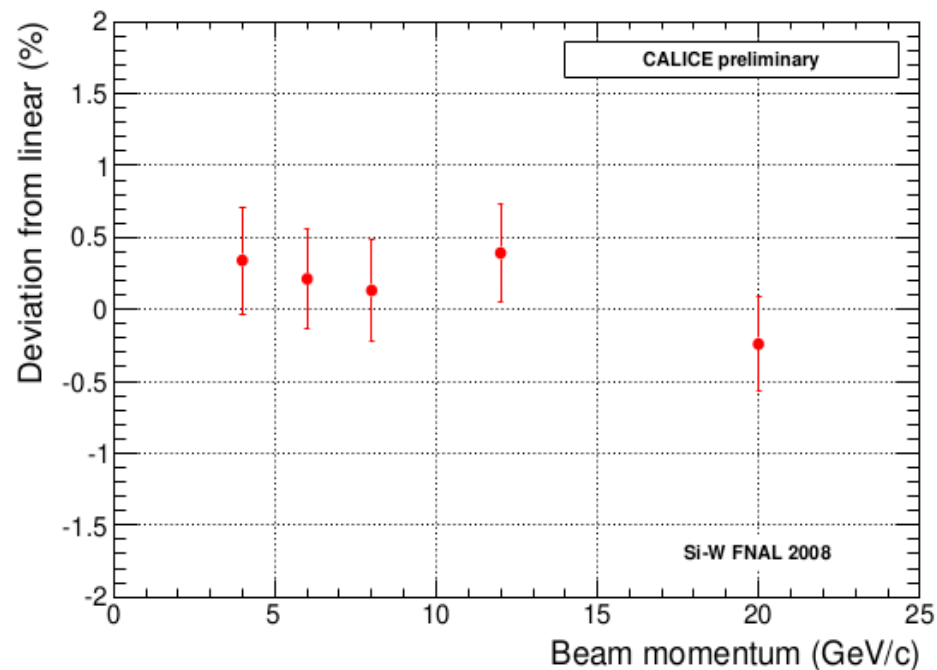
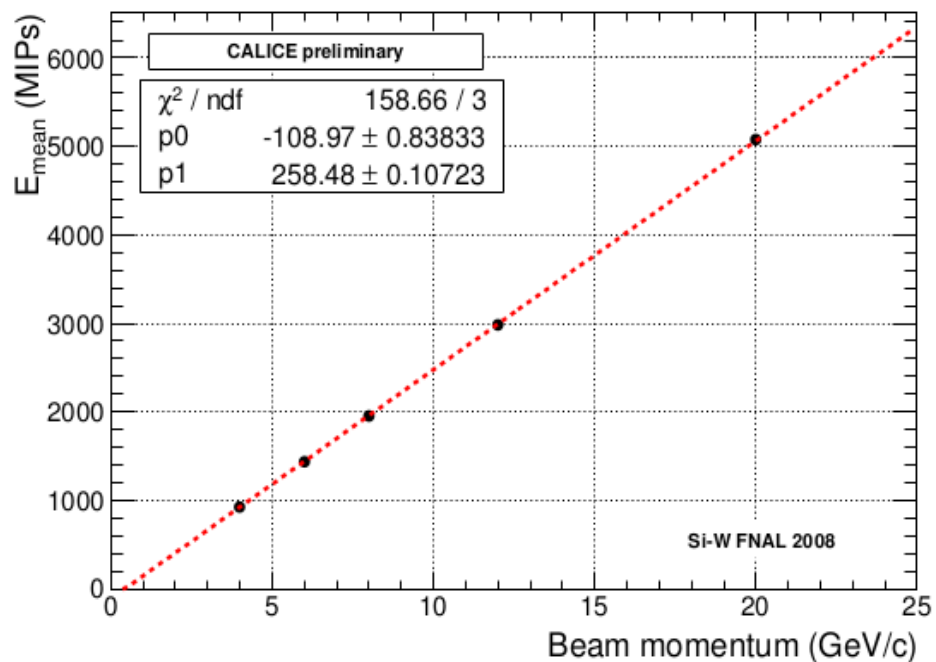
Described in public CALICE analysis note

Miyazaki (Kyushu)

Investigate ways
to treat gaps
between wafers

gaps are \sim projective in
prototype, but not in ILD





In central region (~no leakage),
including beam energy spread

$$\sigma_E/E \sim (16.5-18.3)\%/\sqrt{E} \oplus (1.6-1.9)\%$$

depending on region

consistent with previous results
constant term larger due to
significant beam energy spread

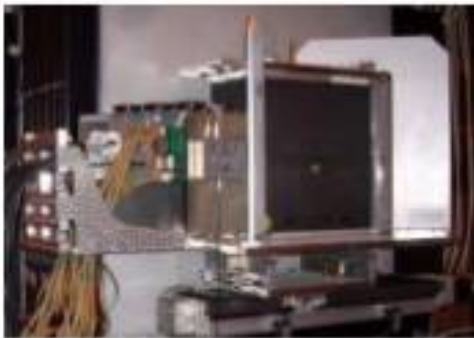
Measure how well 2 electron showers can be separated in ECAL

Investigate pattern recognition capabilities crucial for PFA

Physics Prototype

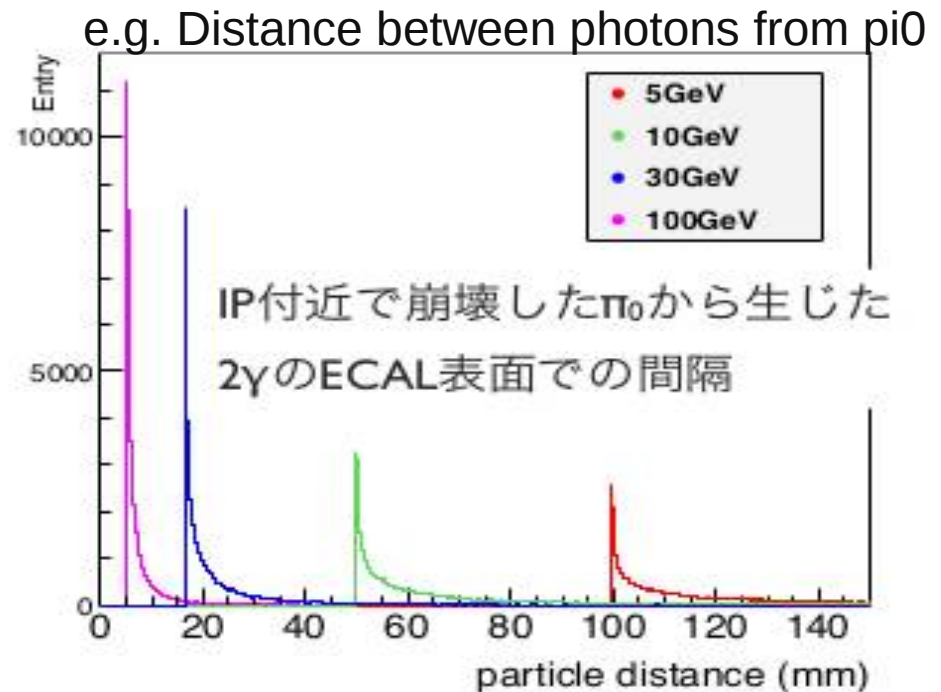
Proof of principle

2003 - 2011



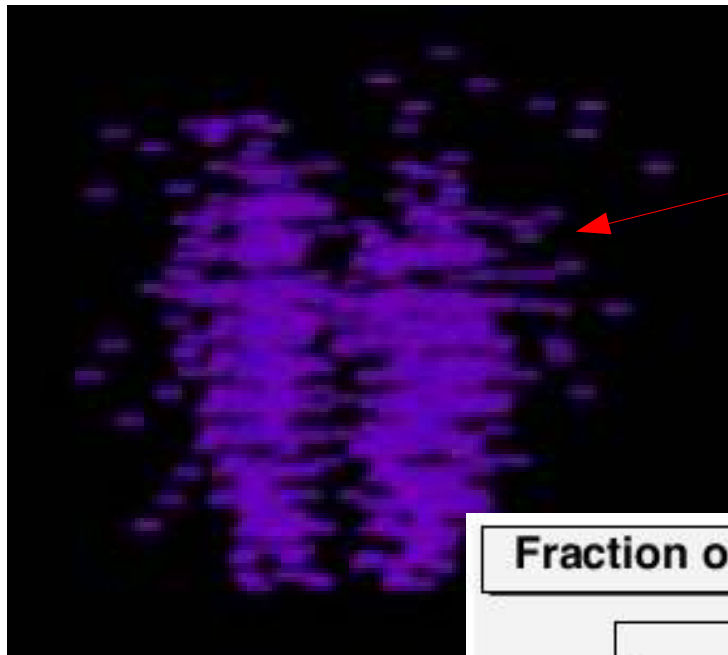
Number of channels : **9720**

Weight : ~ **200 Kg**



Overlay 2 test beam events,
apply PandoraPFA
compare data & simulation

Chen (Tokyo)



Two overlaid electron events from test beam

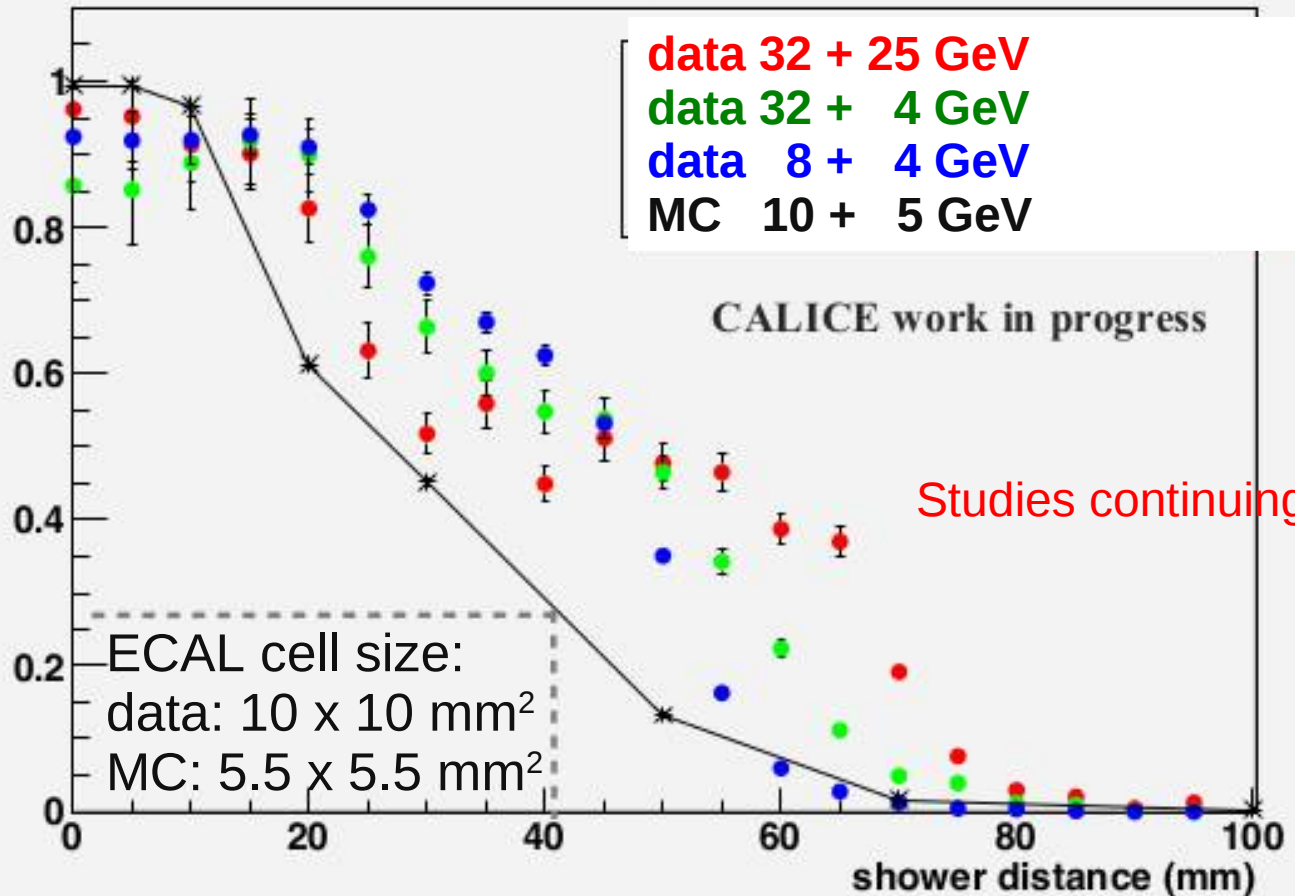
Apply PandoraPFA
 (treat clusters as photons: ignore track information)

Fraction of events with $n_{\text{PFO}} \leq 1$

fraction of events in which clusters have been merged

vs.

distance between clusters



data 32 + 25 GeV
 data 32 + 4 GeV
 data 8 + 4 GeV
 MC 10 + 5 GeV

CALICE work in progress

Studies continuing...

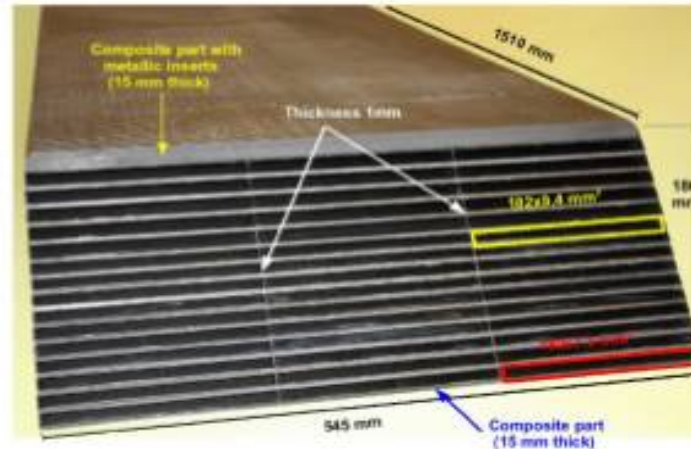
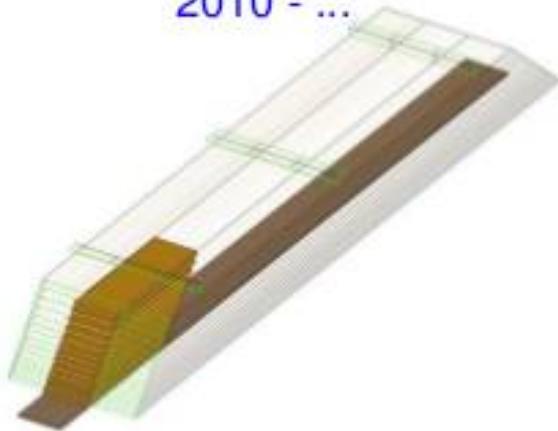
Technological prototype:

Develop, test and debug technologies
Critical stage for TDR preparation

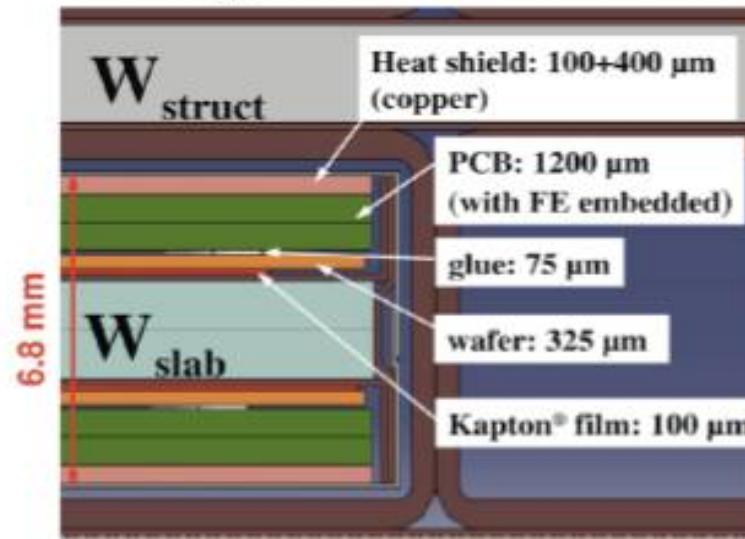
Technological Prototype

Engineering challenges

2010 - ...



Prototype: 3/5 of one module.



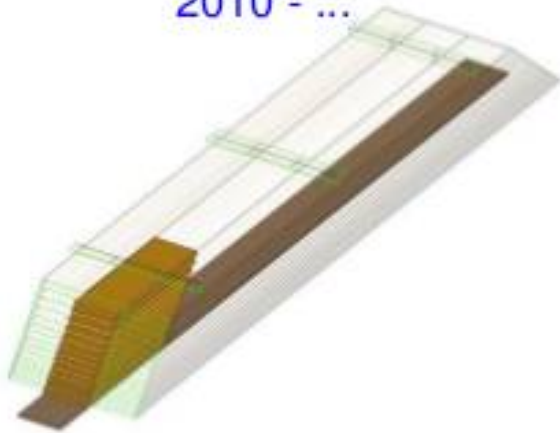
Number of channels : 45360

Weight : ~ 700 Kg

Technological Prototype

Engineering challenges

2010 - ...



Number of channels : 45360

Weight : ~ 700 Kg

Technological prototype:

Develop, test and debug technologies
Critical stage for TDR preparation

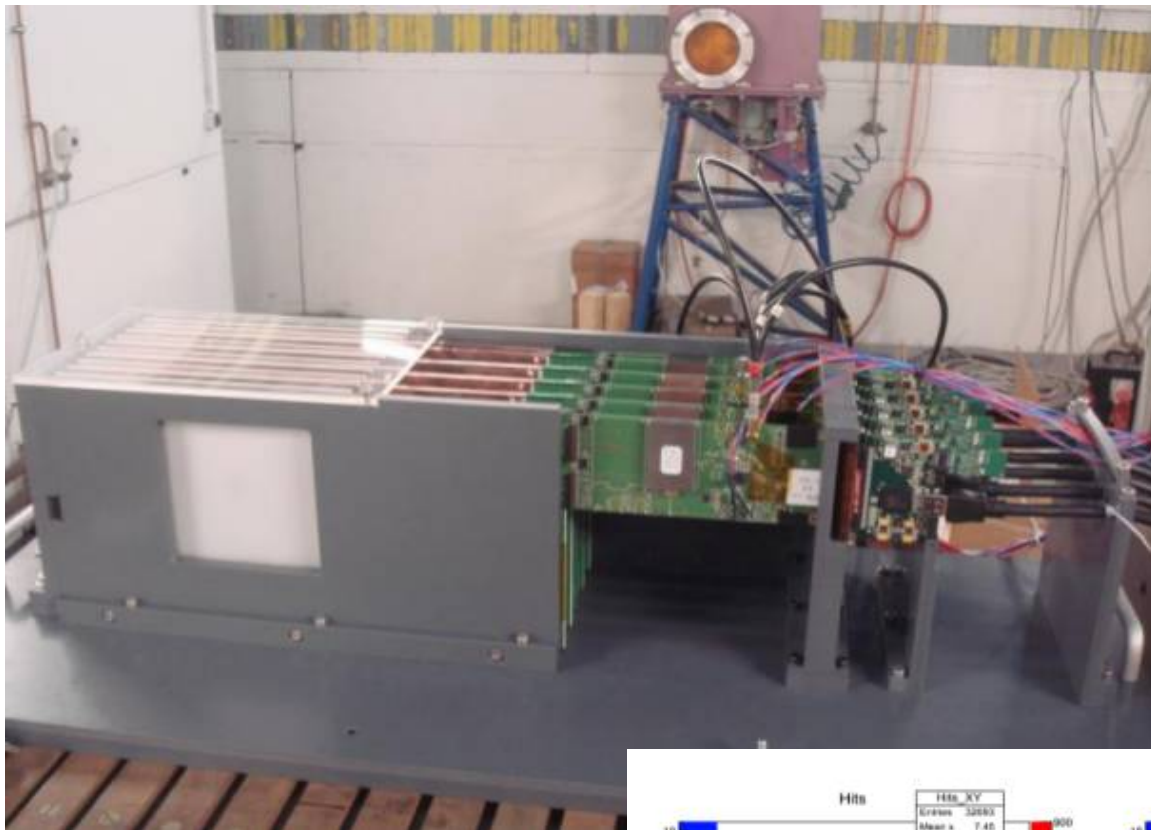
2nd testbeam @ DESY (July 2013)

~7 layers, each 9x9cm², 256 readout channels

System tests
including power pulsing

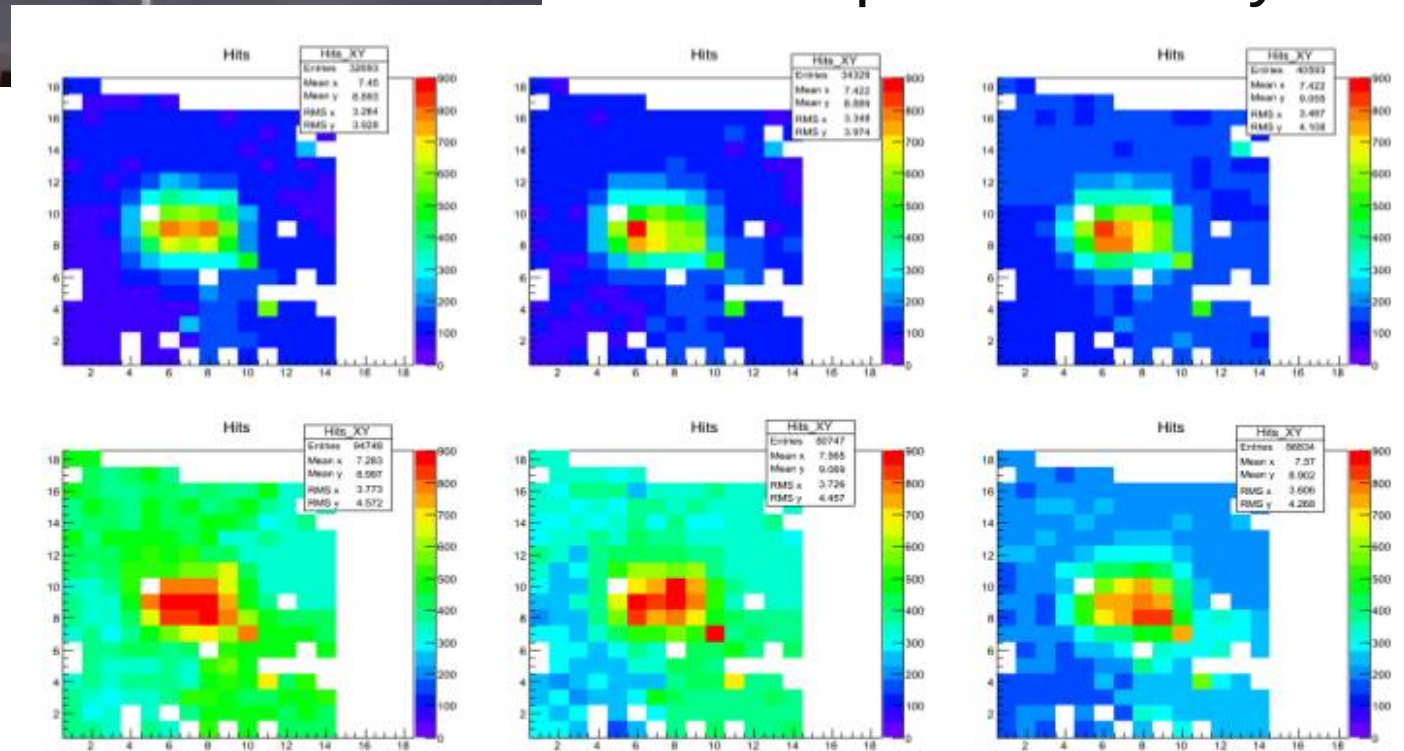
Large participation from Japan

Combined running with ScECAL layers



Testbeam @ DESY

Beam profile in 6 layers



More details in Sudo-san's talk later

Other ongoing engineering studies

(mostly in France)

“Long slab”

Preparations underway to test long detector slab
up to ~2m long required in ILD
check clean signal propagation over long distances
Practice detector construction and integration

“Relaxed” design of central PCB

thicker → easier to produce flat board
(required for sensor gluing)
ASICs in BGA package

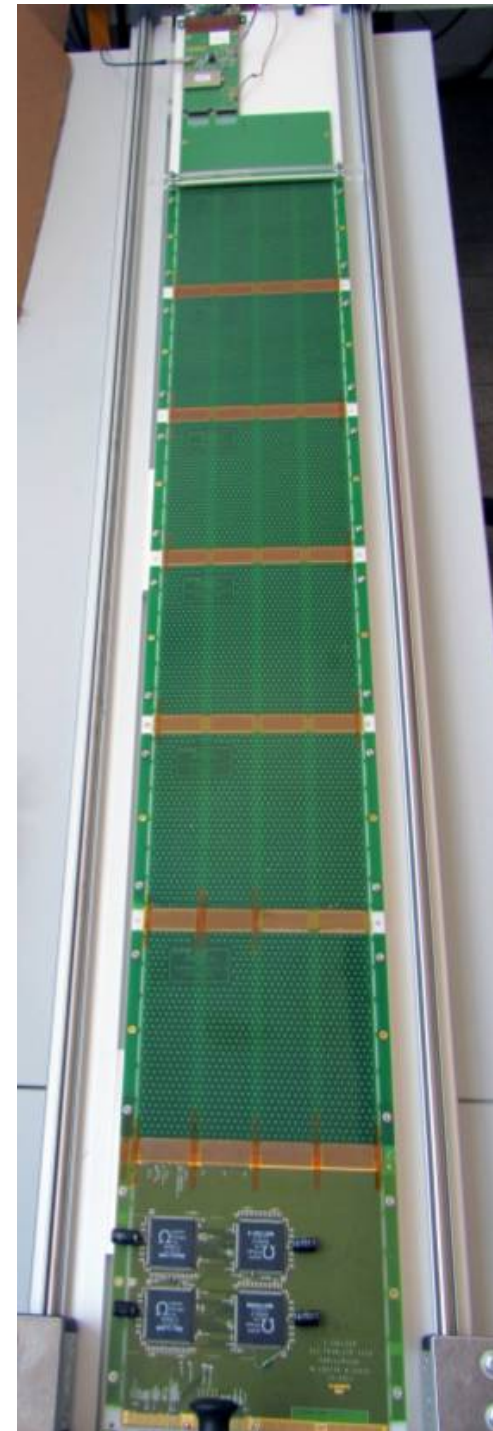
“Agressive” PCB design:

thinner → more compact detector
Bare ASICs wire bonded into PCB

Cooling, services, integration, ...

DAQ system

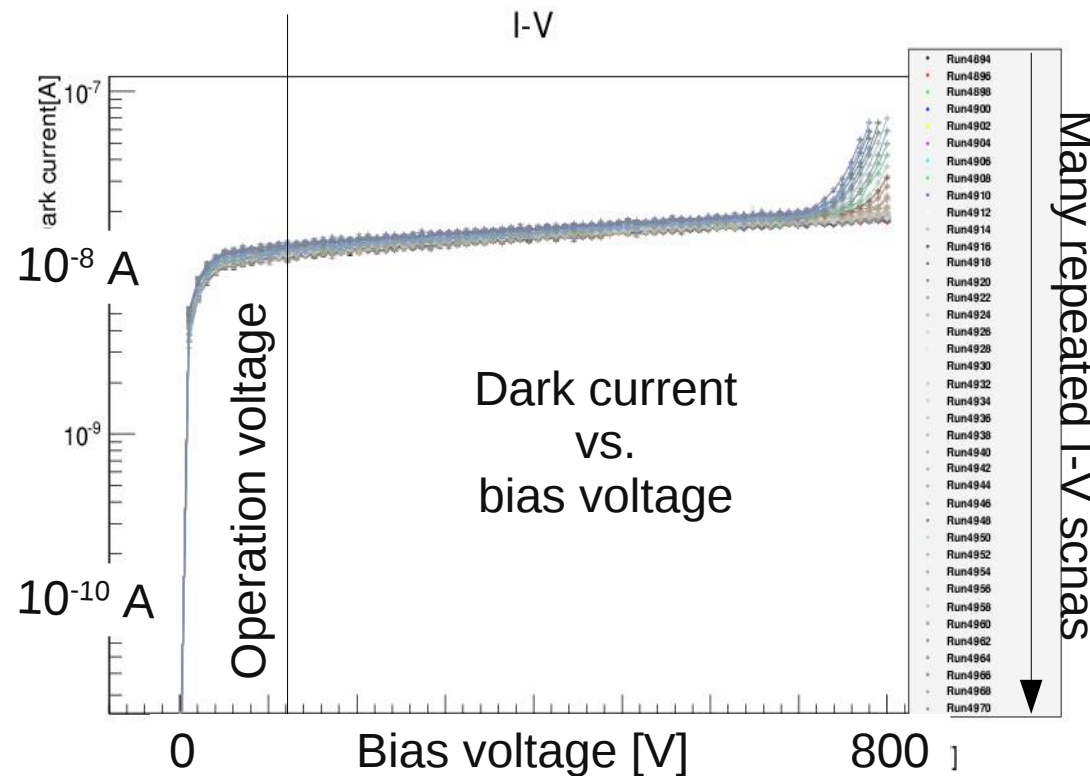
Suehara-san @ Kyushu has started to work in this area
for hybrid si-scint ECAL readout



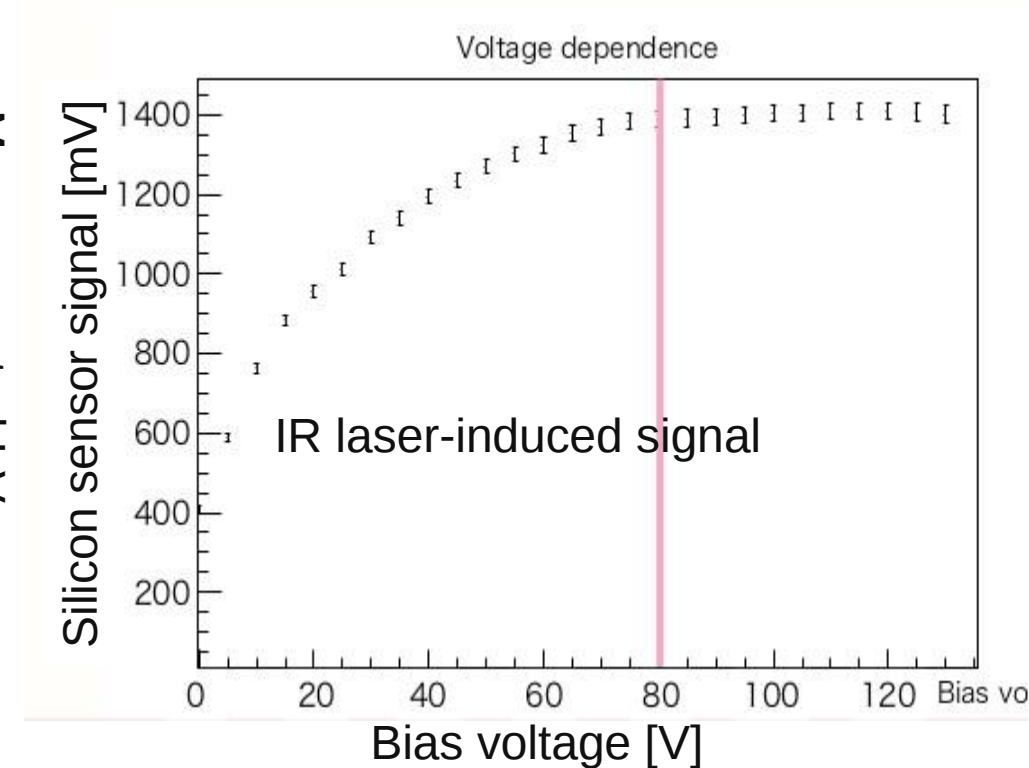
Measurement and development of silicon sensors

- investigate different designs (esp. of guard ring structure at sensor edge)
- Close relation to HPK (including cost estimates for large production)
- Preparing for future large scale testing

Electrical properties



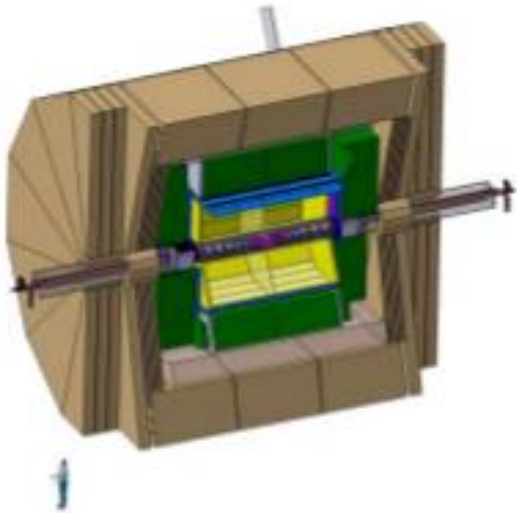
Laser injection



More details in Tomita-san's talk later

Preparations for ILC detector

LC detector



ECAL :

Channels : ~100 10^6

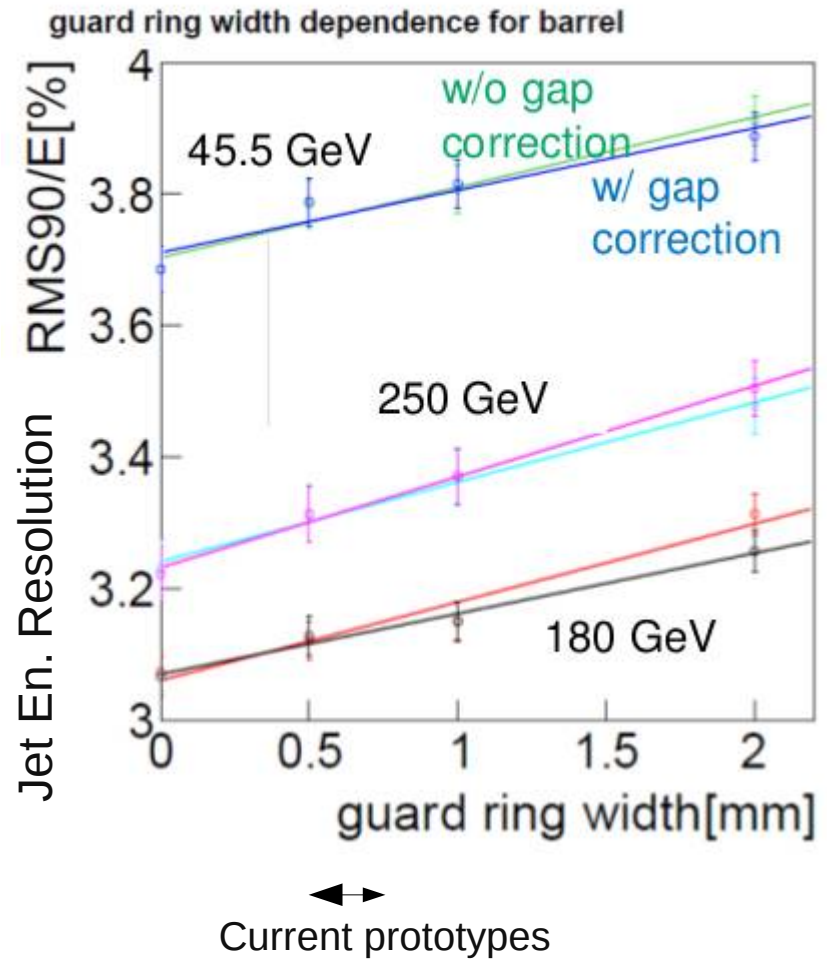
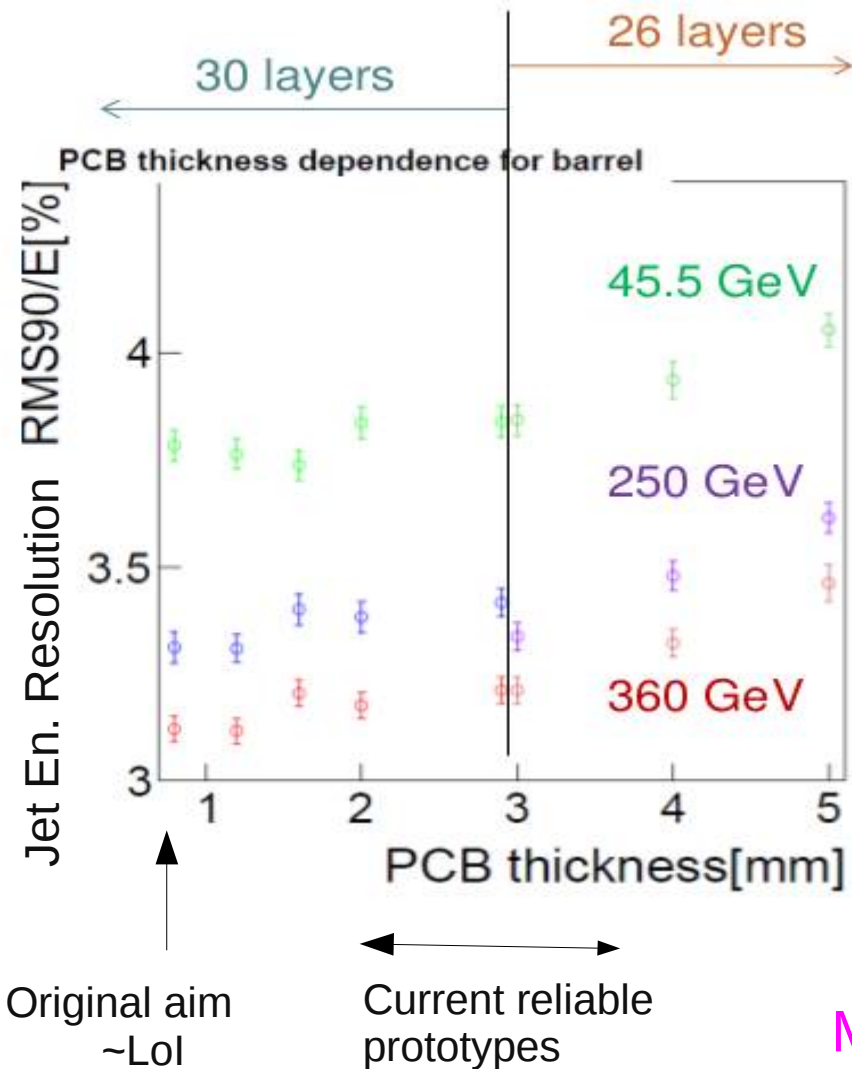
Total Weight : ~130 t

- finalise ECAL technical design
realistic and proven technologies
- control cost (major fraction of ILD)
Cost vs. performance
global parameters
internal parameters

Influence of design parameters

How aggressive does design really need to be?

Can we relax requirements?



For Jet Energy Resolution, we have some space to relax

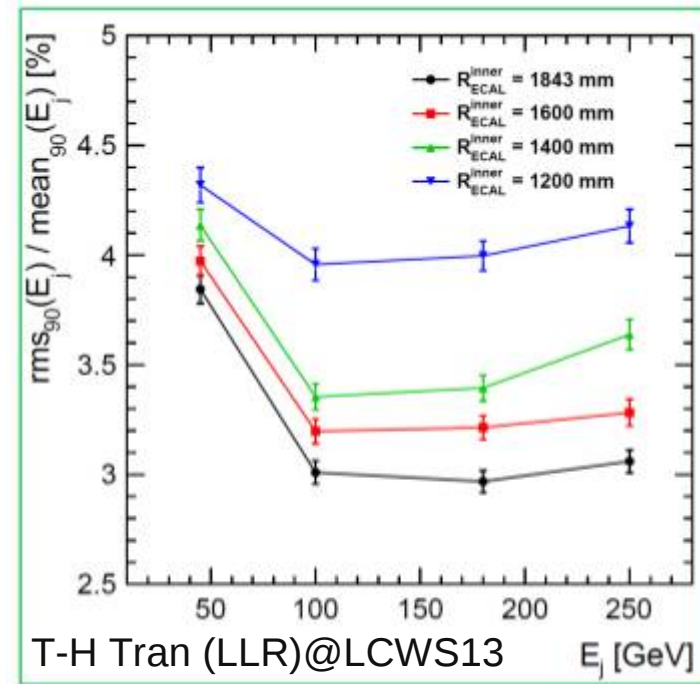
Other measures may be more sensitive will look at 2-particle separation

More details in Kozakai-san's talk later

Cost optimisation

Largest components of ECAL cost scale with sensitive area: Si sensors and PCBs

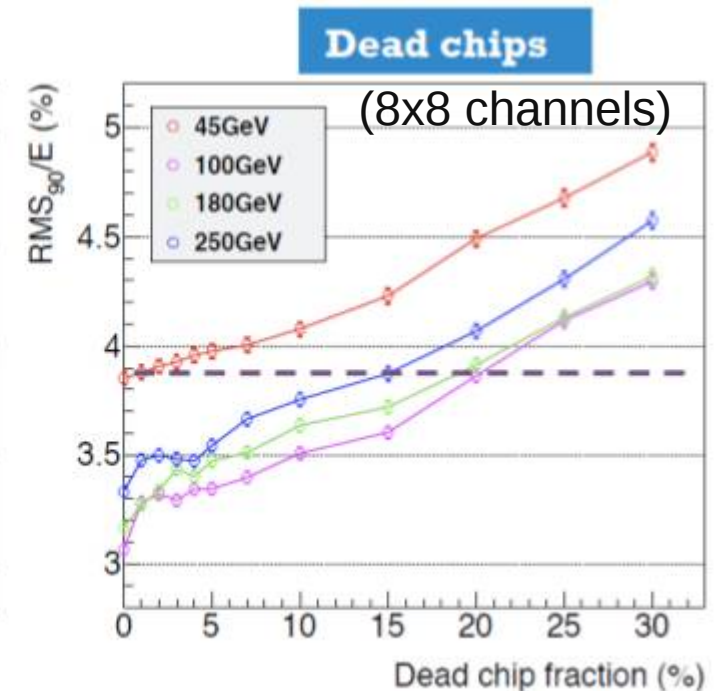
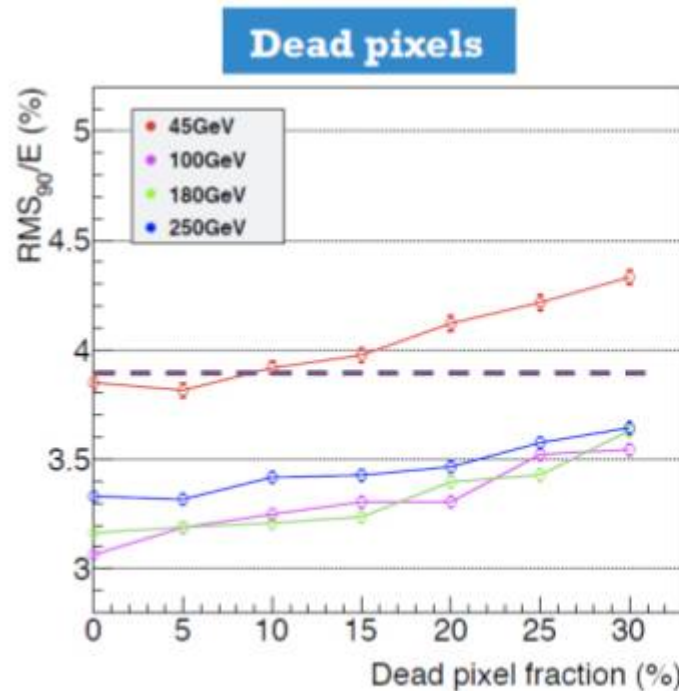
Number of ECAL layers, and radius of ECAL are therefore major cost parameters



Largest cost component = silicon sensors
now have first cost estimate from HPK for large scale production

How important is sensor quality?

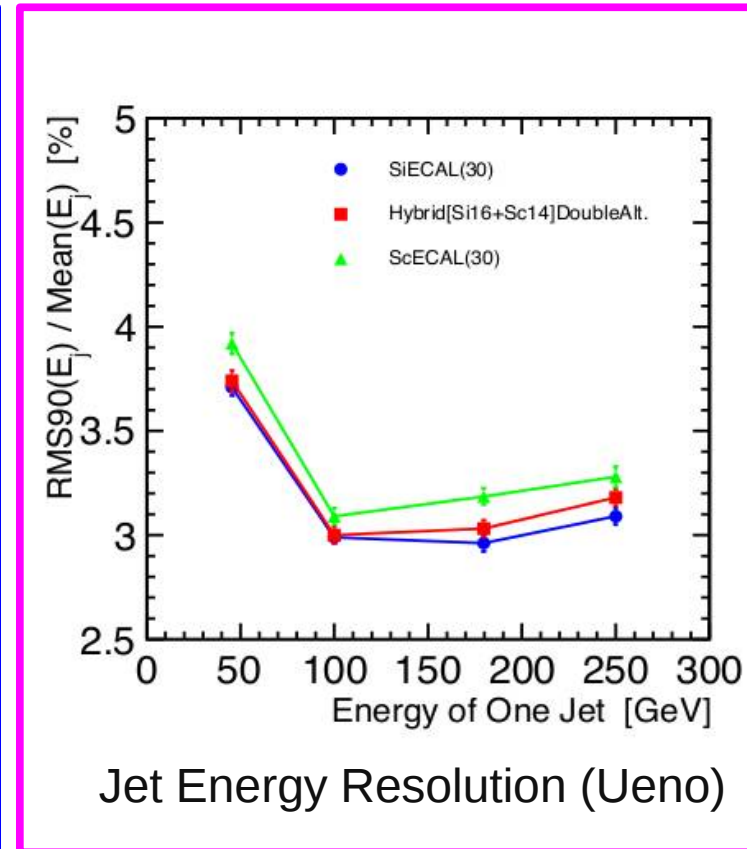
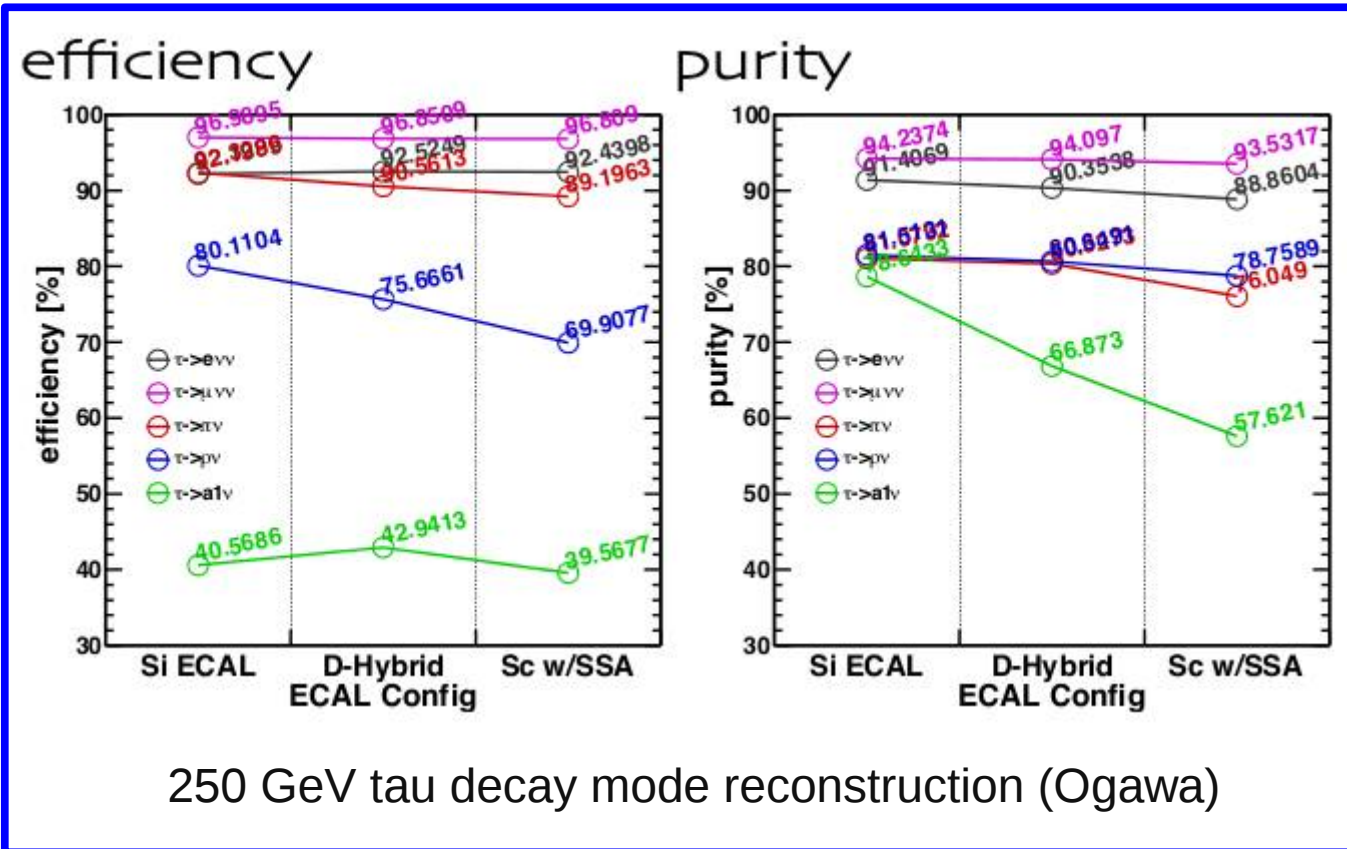
A few % unusable channels has ~no effect on jet energy measurement



Studies of Hybrid silicon-scintillator ECAL

Studies by Ueno-san (Kyushu) and Ogawa-san (Shinshu) comparing silicon, scintillator and hybrid ECAL designs

Jet Energy Resolution and tau reconstruction



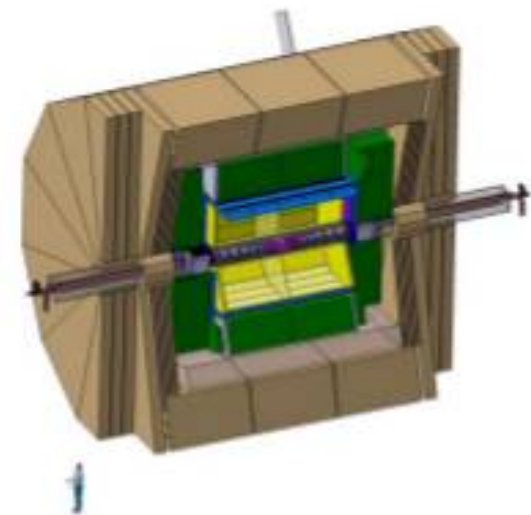
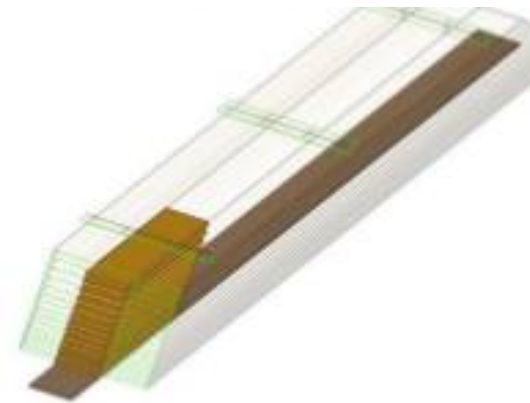
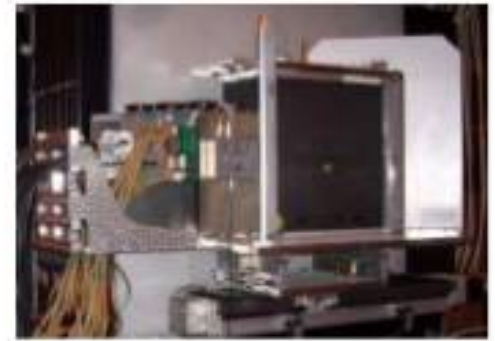
We are trying to define detector models and digitisation between technologies to ensure a similar level of confidence in simulation results

First (~parasitic) test beam trial in summer 2013;
DAQ improvements underway @ Kyushu

more details of hybrid studies in Ueno-san's talk tomorrow

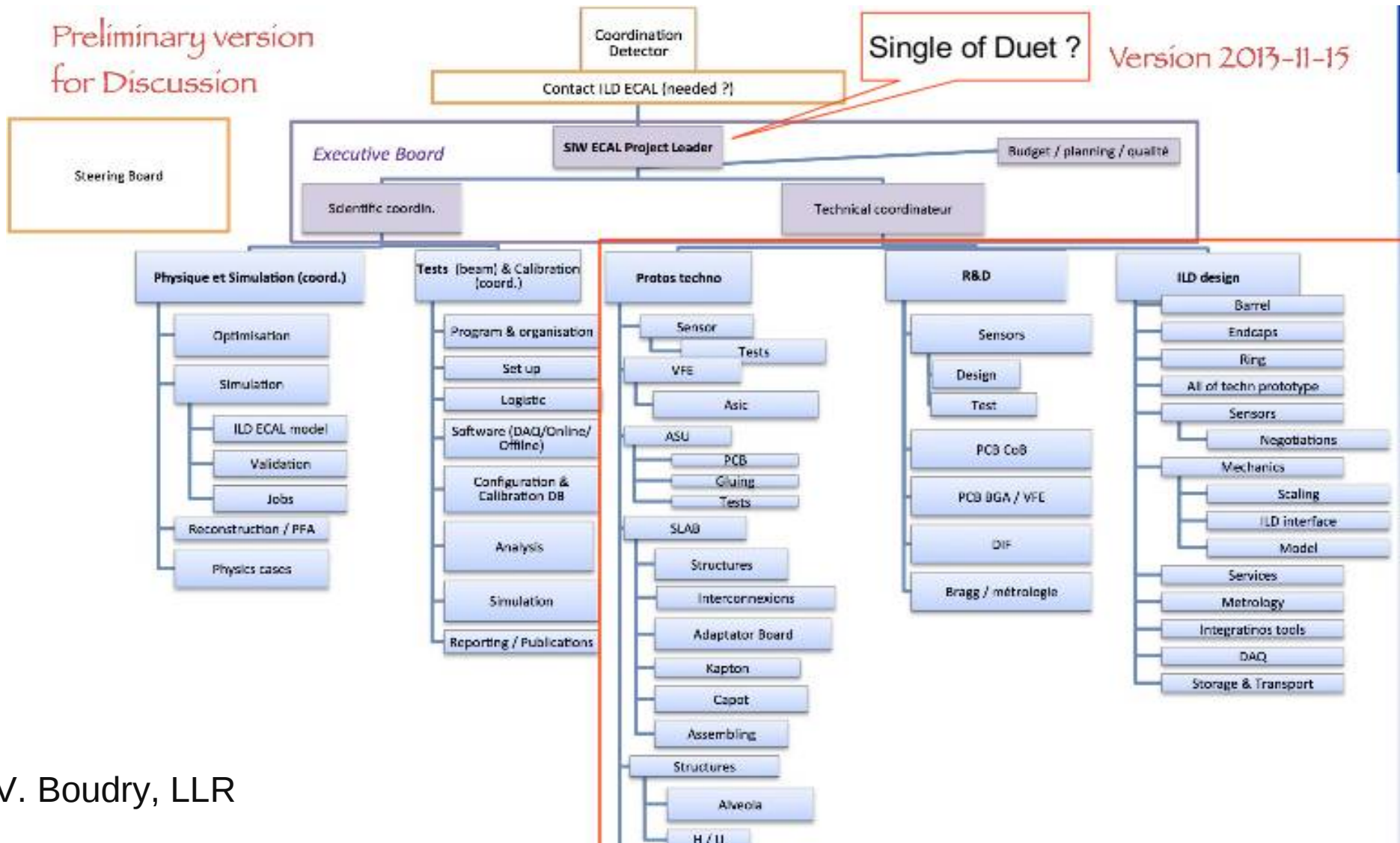
Plans for next year

- further analyses of “physics prototype”
 - Finalise energy resolution study
 - Develop 2-particle studies
- development for technological prototype
 - Detailed comparison of different sensor designs
 - laser system
 - neutron radiation tests
 - Reliable combined operation of silicon and scintillator layers
 - Manufacture of PCB in Japanese company
- further optimisation studies for ILD
 - ensure similar realism of different options' simulation
 - cost-performance studies



ECAL construction will take many years,
 so we should not be much behind ILC schedule
 We need to be ready to react quickly and efficiently after ILC decision
 accept new contributors, finalise design, define and allocate work packages..

start thinking about how to organise and manage ECAL construction



Summary

- performance of first “physics” prototype is well understood and stable
- technological prototype is under development to select technologies for final detector
- simulation studies underway to understand required quality, uniformity, ... inform choice of final detector size, configuration & cost